

File No. 14836-9US AD/bns

Montréal, CANADA,

February 29, 2008

UNITED STATES PATENT AND TRADEMARK OFFICE

Application No : 10/532,627
Filing Date : April 25, 2005
Applicant : Microbridge Technologies Inc.
Inventor : Leslie M. Landsberger et al.
Title of Invention : METHOD FOR PRODUCING A PACKAGED INTEGRATED
CIRCUIT
Classification : 2822
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Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

USA

RESPONSE AFTER FINAL

Sir:

In response to the Office Action dated December 13, 2007 in connection with the above-identified Application, please consider the following:

Amendments to the claims begin on page 2 of this paper.

Amendments to the specification begin on page 8 of this paper.

Amendments to the drawings begin on page 11 of this paper.

Remarks begin on page 12 of this paper.

An **Appendix** including replacement drawing sheets is included after page 13 of this paper.